

This is a preview - click here to buy the full publication



IEC 62037-1

Edition 1.0 2012-05

INTERNATIONAL STANDARD



Passive RF and microwave devices, intermodulation level measurement – Part 1: General requirements and measuring methods

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

PRICE CODE



ICS 33.040.20

ISBN 978-2-83220-110-7

Warning! Make sure that you obtained this publication from an authorized distributor.

CONTENTS

FOREWORD.....	3
1 Scope.....	5
2 Normative references.....	5
3 Abbreviations.....	5
4 Characteristics of intermodulation products.....	5
5 Principle of test procedure.....	6
6 Test set-up.....	6
6.1 General.....	6
6.2 Test equipment.....	6
6.2.1 General.....	6
6.2.2 Set-up 1.....	7
6.2.3 Set-up 2.....	8
7 Preparation of DUT and test equipment.....	8
7.1 General.....	8
7.2 Guidelines for minimizing generation of passive intermodulation.....	8
8 Test procedure.....	10
9 Reporting.....	10
9.1 Results.....	10
9.2 Example of results.....	10
10 Measurement error.....	11
Annex A (informative) Configuration of low-PIM termination.....	15
Annex B (informative) Test procedure considerations.....	17
Figure 1 – Set-up 1; reverse IM-test set-up.....	12
Figure 2 – Set-up 2; forward IM-test set-up.....	13
Figure 3 – Passive intermodulation (PIM) measurement error caused by residual system error.....	14
Figure A.1 – Long cable termination.....	15
Figure A.2 – Lumped termination with a linear attenuator.....	16
Table 1 – Guide for the design, selection of materials and handling of components that may be susceptible to PIM generation.....	9
Table 2 – Test set-up conditions.....	10

INTERNATIONAL ELECTROTECHNICAL COMMISSION

PASSIVE RF AND MICROWAVE DEVICES, INTERMODULATION LEVEL MEASUREMENT –

Part 1: General requirements and measuring methods

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as “IEC Publication(s)”). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 62037-1 has been prepared by technical committee 46: Cables, wires, waveguides, R.F. connectors, R.F. and microwave passive components and accessories.

This first edition of IEC 62037-1 replaces IEC 62037, published in 1999. It constitutes a technical revision.

The text of this standard is based on the following documents:

FDIS	Report on voting
46/402/FDIS	46/416/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all the parts in the IEC 62037 series, published under the general title *Passive RF and microwave devices intermodulation level measurement*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this standard may be issued at a later date.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

PASSIVE RF AND MICROWAVE DEVICES, INTERMODULATION LEVEL MEASUREMENT –

Part 1: General requirements and measuring methods

1 Scope

This part of IEC 62037 deals with the general requirements and measuring methods for intermodulation (IM) level measurement of passive RF and microwave components, which can be caused by the presence of two or more transmitting signals.

The test procedures given in this standard give the general requirements and measurement methods required to characterize the level of unwanted IM signals using two transmitting signals.

The standards in this series address the measurement of PIM, but do not cover the long term reliability of a product with reference to its performance.

This standard is to be used in conjunction with other appropriate part(s) of IEC 62037.

2 Normative references

None.